COMPACT<u>FLOOR</u>®

Wärmeleitschichten · Conductive Layers

CompactFloor[®] **THERM CE**

Installation



Lay out the edge insulation strips, carefully clean the subsurface and prime for sufficient adhesion with the deep primer.

Open spaces must be suitably closed with wooden beam ceilings. Separating layers, for example films, are not permissible as anti-ripple protection. Observe the technical datasheets an safety guidelines prior to processing.



Stir water (3.75 litres) and CE binder (1 sack) into a bucket with an agitator at medium speed.



Add the entire contents of the granulate sack into a mortar bucket and add the pre-mixed CE binder.



Carefully mix for 3 minutes in an agitator. For an improved mixing result, transfer into a second mortar bucket and re-mix for one minute.



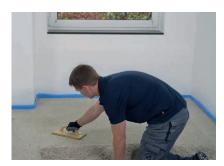
Form dams based on the metre level in the height profile. Layer thickness at least 30 mm to max. 500 mm.



Fill up the area between the dams and densify by knocking them with a trowel.



Strip the surface, retaining the height profile.



Then smooth the surface with a trowel. The processing time is 60 minutes.



After 12 hours drying time, the area can be walked on, and after 3 - 4 days, it can be laid. Observe: CompactFloor THERM CE is not a finished usable layer on which floor coverings can be directly laid.